

3SK324

Si Nch Dual Gate MOS FET UHF RF LOW NOISE Amplifier

REJ03G0532-0100 Rev.1.00 May 18, 2005

Features

- Low noise characteristics; NF = 1.0 dB typ. (at f = 900 MHz)
- High gain characteristics; PG = 24 dB typ. (at f = 900 MHz)
- Capable low voltage operation; +B = 3.5 V
- High Endurance Voltage; $V_{DS} = 6 \text{ V}$

Outline

RENESAS Package code: PTSP0004ZA-A

(Package name: CMPAK-4)



- 3. Gate2
- 4. Drain

Notes: 1. Marking is "UG-".

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DS}	6		
Gate1 to source voltage	V_{G1S}	+6 -6	V	
Gate2 to source voltage	V _{G2S}	+6 -6	V	
Drain current	ID ID	20	mA	
Channel power dissipation	Pch ^{*2}	250	mW	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	−55 to +150	°C	

Notes: 2. Value on the glass epoxy board (50 mm \times 40 mm \times 1 mm).

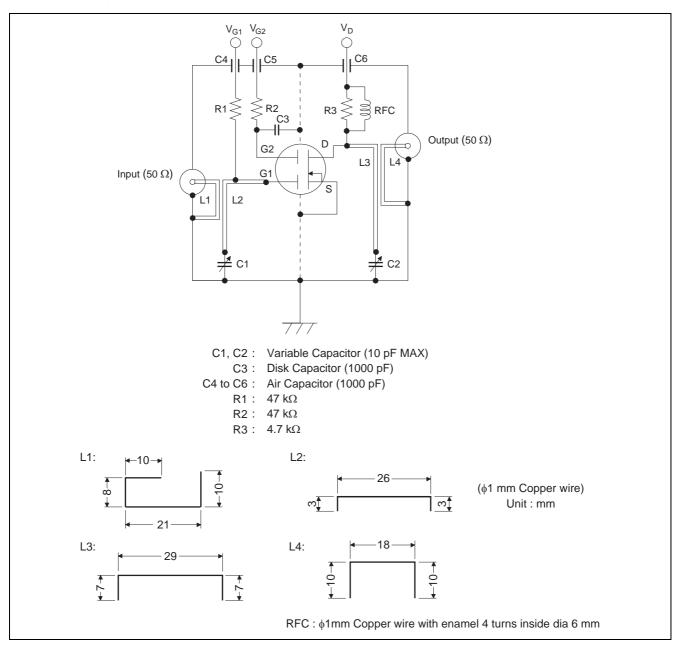


Electrical Characteristics

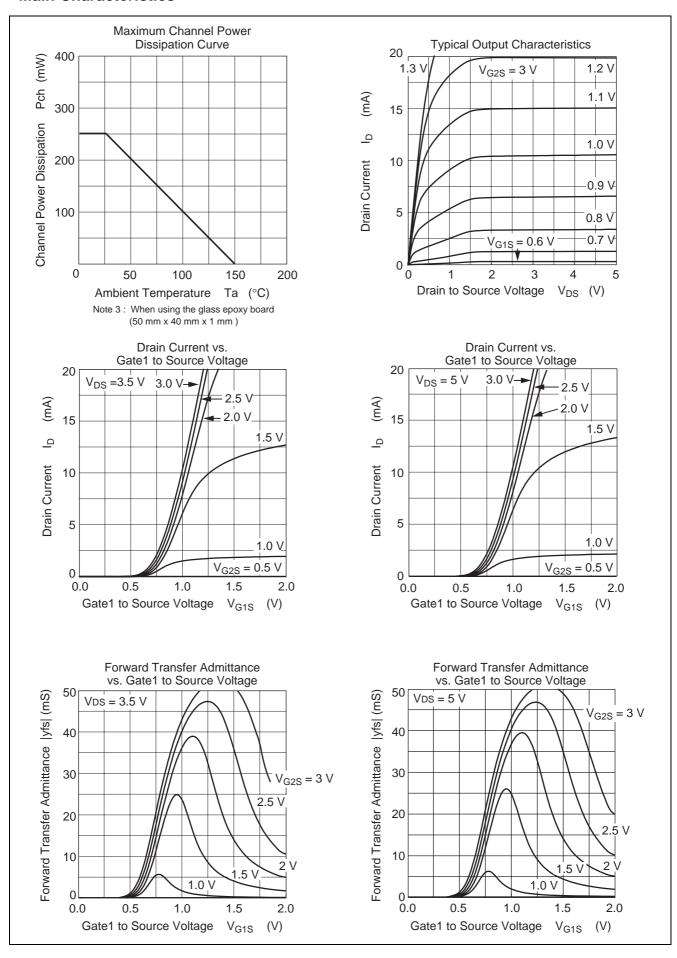
 $(Ta = 25^{\circ}C)$

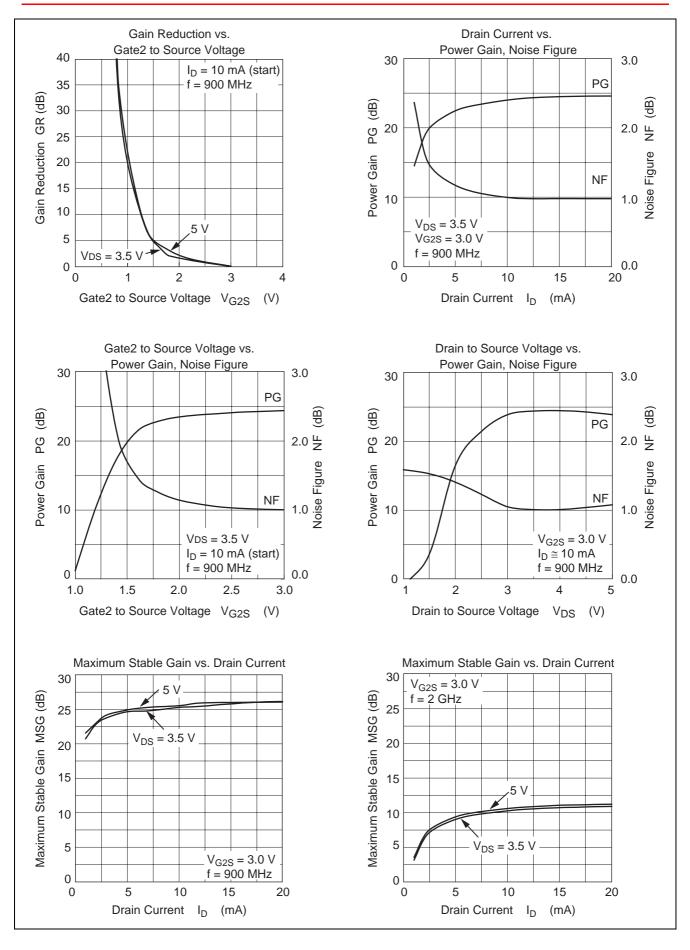
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6			V	$I_D = 200 \mu\text{A}, V_{\text{G1S}} = V_{\text{G2S}} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	±6			V	$I_{G1} = \pm 10 \ \mu A, \ V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	±6	_	_	V	$I_{G2} = \pm 10 \ \mu A, \ V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I _{G1SS}	_	_	±100	nA	$V_{G1S} = \pm 5 \text{ V}, V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I _{G2SS}	_	_	±100	nA	$V_{G2S} = \pm 5 \text{ V}, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	V _{G1S(off)}	0	0.5	1	V	$V_{DS} = 5 \text{ V}, V_{G2S} = 3 \text{V}, I_D = 100 \mu\text{A}$
Gate2 to source cutoff voltage	V _{G2S(off)}	0.3	0.7	1.1	V	$V_{DS} = 5 \text{ V}, V_{G1S} = 3 \text{ V}, I_{D} = 100 \mu\text{A}$
Forward transfer admittance	y _{fs}	30	42	_	mS	$V_{DS} = 3.5 \text{ V}, I_D = 10 \text{ mA},$
						$V_{G2S} = 3 \text{ V, f} = 1 \text{ kHz}$
Power gain	PG	20	24	_	dB	$V_{DS} = 3.5 \text{ V}, I_D = 10 \text{ mA},$
Noise figure	NF	_	1.0	1.6	dB	$V_{G2S} = 3 \text{ V, f} = 900 \text{ MHz}$

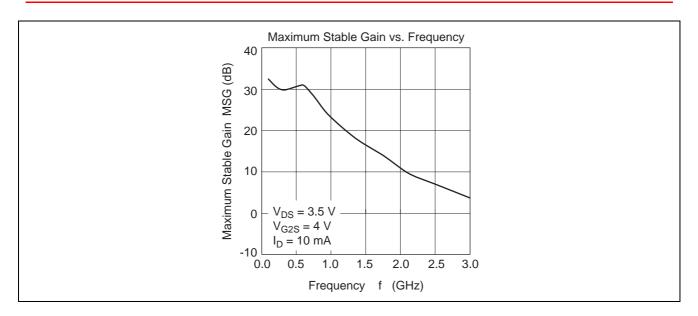
900MHz PG, NF Test Circuit



Main Characteristics





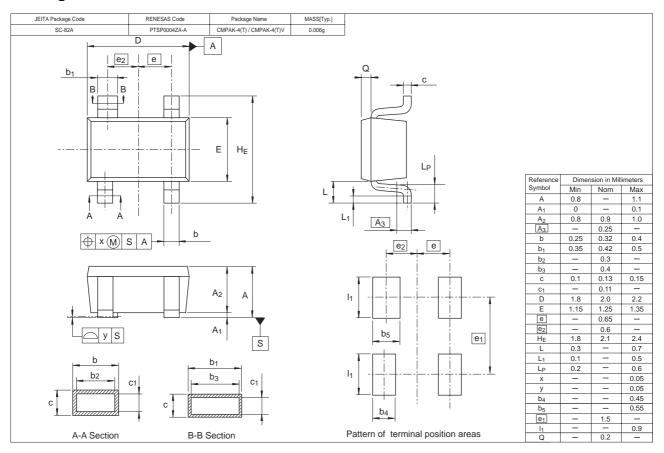


S parameter

 $(V_{DS}=3.5~V,\,V_{G2S}=4~V,\,I_D=10~mA,\,Zo=\!50~\Omega)$

	S11 S21		21	1 S12			S22	
f (GHz)	Mag	Phase	Mag	Phase	Mag	Phase	Mag	Phase
0.1	0.996	-6.0	4.33	170.1	0.002	139.0	0.992	-6.1
0.2	0.989	-11.7	4.23	160.5	0.003	84.8	0.988	-11.9
0.3	0.973	-17.1	4.15	151.2	0.003	96.9	0.978	-17.7
0.4	0.956	-22.6	4.06	142.1	0.004	75.9	0.963	-23.5
0.5	0.940	-27.8	3.94	133.5	0.004	82.6	0.948	-28.9
0.6	0.920	-32.9	3.84	125.0	0.003	91.7	0.931	-34.4
0.7	0.899	-37.7	3.73	116.7	0.004	132.5	0.915	-39.6
0.8	0.879	-42.4	3.62	108.6	0.005	157.1	0.899	-44.7
0.9	0.858	-46.9	3.52	100.5	0.010	169.9	0.883	-49.7
1.0	0.840	-51.3	3.42	92.5	0.014	173.8	0.869	-54.5
1.1	0.816	-55.5	3.30	84.4	0.020	174.8	0.857	-59.3
1.2	0.794	-59.3	3.19	76.2	0.028	175.0	0.846	-63.9
1.3	0.772	-62.8	3.08	67.8	0.036	169.6	0.838	-68.5
1.4	0.752	-66.0	2.97	59.2	0.048	165.1	0.835	-72.9
1.5	0.734	-68.5	2.84	49.4	0.058	160.8	0.837	-77.3
1.6	0.727	-69.7	2.63	38.2	0.069	156.3	0.849	-82.4
1.7	0.754	-70.0	2.28	26.6	0.079	152.6	0.867	-88.1
1.8	0.825	-73.3	1.77	20.3	0.092	152.4	0.869	-95.5
1.9	0.877	-80.3	1.47	24.7	0.111	150.7	0.847	-102.1
2.0	0.890	-88.0	1.45	29.7	0.136	147.2	0.818	-108.0
2.1	0.882	-94.7	1.52	28.9	0.162	142.4	0.796	-112.9
2.2	0.867	-100.9	1.56	25.0	0.192	136.6	0.780	-117.7
2.3	0.851	-106.6	1.58	19.9	0.223	130.5	0.766	-122.4
2.4	0.834	-112.1	1.56	14.4	0.256	123.9	0.753	-127.3
2.5	0.816	-117.5	1.54	8.8	0.294	117.3	0.739	-132.2
2.6	0.795	-122.8	1.50	3.2	0.333	109.8	0.724	-137.2
2.7	0.771	-128.1	1.47	-2.2	0.374	101.9	0.706	-142.2
2.8	0.744	-133.2	1.43	-7.7	0.416	93.6	0.681	-146.9
2.9	0.713	-138.1	1.39	-12.9	0.458	84.6	0.654	-151.2
3.0	0.677	-142.4	1.36	-18.3	0.497	74.7	0.624	-154.8

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
3SK324UG-	3000 pcs.	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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